

## 5<sup>th</sup> Asia-Pacific Conference on Plasma Physics, 26 Sept-1Oct, 2021, Remote e-conference **Fast preparation of functional films by helicon-wave-excited plasma source**

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Basing on low pressure, high density helicon-wave-excited plasma (HWP) source [1], tungsten nitride [2] and carbon-based (vertical graphene nanosheets and multi wall carbon nanotube arrays) [3,4] functional films have been synthesized on silicon substrates by physical sputtering and chemical vapor deposition techniques with high deposition rate at room-temperature, respectively. The structure, composition, morphology, mechanical and electrical properties of the films have been lucubrated. Meanwhile, by monitoring the plasma parameters which are crucial for the film nucleation and growth features, such as the ion flux and energy toward the substrates and the reactive species densities near the film surface, progress has been made on comprehending the film synthesis mechanisms and understanding how the film properties can be modified by the available deposition parameters such as plasma excitation power, substrate location and temperature, target bias, gas pressure and flow rates. This work not only presents an innovative method for the deposition of tungsten nitride and carbon-based functional films with tunable structure, composition and properties but also reveals the dynamic process of film preparation both by HWP physical sputtering and chemical vapor deposition.

deposition, chemical vapor deposition, functional films.

## References

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Note: Abstract should be in (full) double-columned one page.